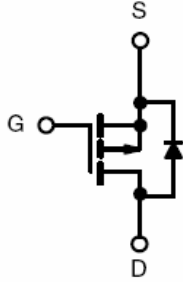
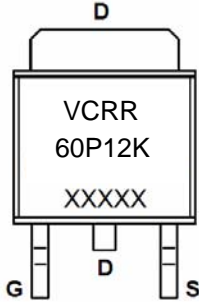
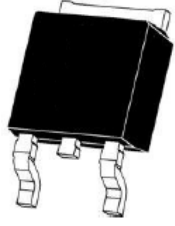


## VCRR P-Channel Enhancement Mode Power MOSFET

<p><b>Description</b></p> <p>The VCRR60P12K uses advanced trench technology and design to provide excellent <math>R_{DS(ON)}</math> with low gate charge .This device is well suited for high current load applications.</p> <p><b>General Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS} = -60V, I_D = -12A</math>  <math>R_{DS(ON)} &lt; 100m\Omega @ V_{GS} = -10V</math>  <math>R_{DS(ON)} &lt; 125m\Omega @ V_{GS} = -4.5V</math></li> <li>● High density cell design for ultra low Rdson</li> <li>● Fully characterized avalanche voltage and current</li> <li>● Good stability and uniformity with high <math>E_{AS}</math></li> <li>● Excellent package for good heat dissipation</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● High side switch for full bridge converter</li> <li>● DC/DC converter for LCD display</li> </ul>	<div style="text-align: center;">  <p><b>Schematic diagram</b></p> </div> <div style="text-align: center;">  <p><b>Marking and pin assignment</b></p> </div> <div style="text-align: center;">  <p><b>TO-252 -2L top view</b></p> </div>
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### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VCRR60P12K	VCRR60P12K	TO-252-2L	- - -		

### Absolute Maximum Ratings ( $T_C = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	-60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	-12	A
Drain Current-Continuous( $T_C = 100^\circ C$ )	$I_D(100^\circ C)$	-8.5	A
Pulsed Drain Current	$I_{DM}$	-30	A
Maximum Power Dissipation	$P_D$	60	W
Derating factor		0.4	W/ $^\circ C$
Single pulse avalanche energy <sup>(Note 5)</sup>	$E_{AS}$	50	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	$^\circ C$

## Thermal Characteristic

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	$R_{\theta JC}$	2.5	°C/W
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## Electrical Characteristics ( $T_C=25^\circ\text{C}$ unless otherwise noted)

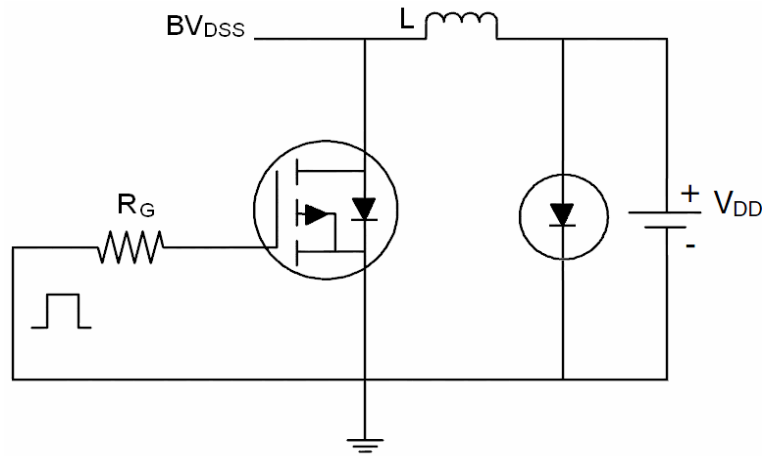
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-60	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=-60V, V_{GS}=0V$	-	-	-1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
<b>On Characteristics</b> <sup>(Note 3)</sup>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1	-1.5	-2.2	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-12A$	-	84	100	m $\Omega$
		$V_{GS}=-4.5V, I_D=-8A$	-	100	125	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=-5V, I_D=-12A$	-	10	-	S
<b>Dynamic Characteristics</b> <sup>(Note 4)</sup>						
Input Capacitance	$C_{ISS}$	$V_{DS}=-30V, V_{GS}=0V,$ $F=1.0\text{MHz}$	-	1630.7	-	PF
Output Capacitance	$C_{OSS}$		-	90.6	-	PF
Reverse Transfer Capacitance	$C_{RSS}$		-	77.3	-	PF
<b>Switching Characteristics</b> <sup>(Note 4)</sup>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=-30V, R_L=1.5\Omega,$ $V_{GS}=-10V, R_G=3\Omega$	-	11	-	nS
Turn-on Rise Time	$t_r$		-	14	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	33	-	nS
Turn-Off Fall Time	$t_f$		-	13	-	nS
Total Gate Charge	$Q_g$	$V_{DS}=-30V, I_D=-12A,$ $V_{GS}=-10V$	-	37.6	-	nC
Gate-Source Charge	$Q_{gs}$		-	4.3	-	nC
Gate-Drain Charge	$Q_{gd}$		-	7.2	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <sup>(Note 3)</sup>	$V_{SD}$	$V_{GS}=0V, I_S=-12A$	-	-	-1.2	V
Diode Forward Current <sup>(Note 2)</sup>	$I_S$		-	-	-12	A
Reverse Recovery Time	$t_{rr}$	$T_J = 25^\circ\text{C}, I_F = -12A$ $di/dt = -100A/\mu s$ <sup>(Note 3)</sup>	-	35	-	nS
Reverse Recovery Charge	$Q_{rr}$		-	38	-	nC
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

### Notes:

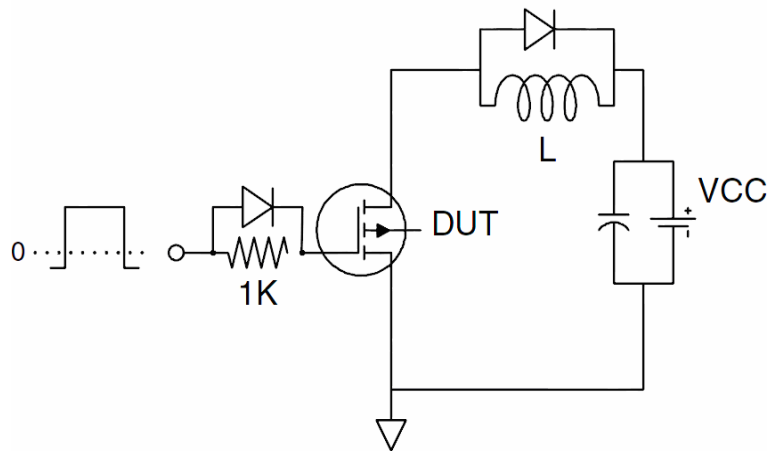
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5.  $E_{AS}$  condition:  $T_J=25^\circ\text{C}, V_{DD}=-20V, V_G=-10V, L=1\text{mH}, R_G=25\Omega$

**Test Circuit**

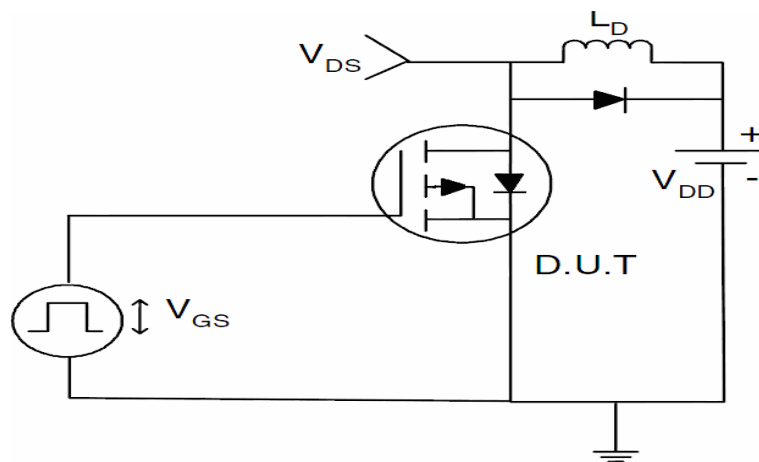
**1) E<sub>AS</sub> Test Circuit**



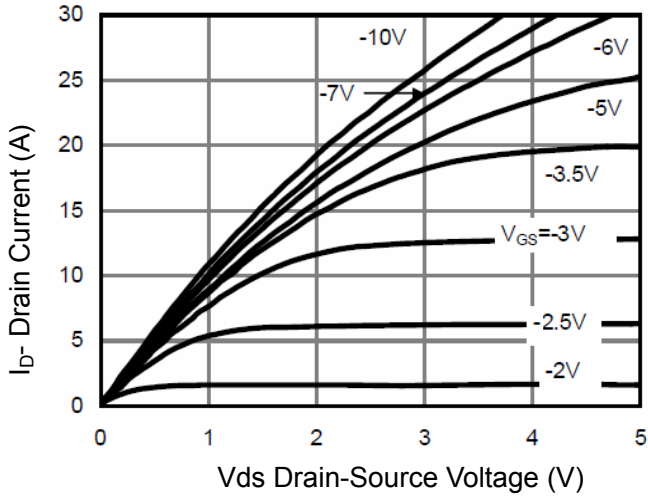
**2) Gate Charge Test Circuit**



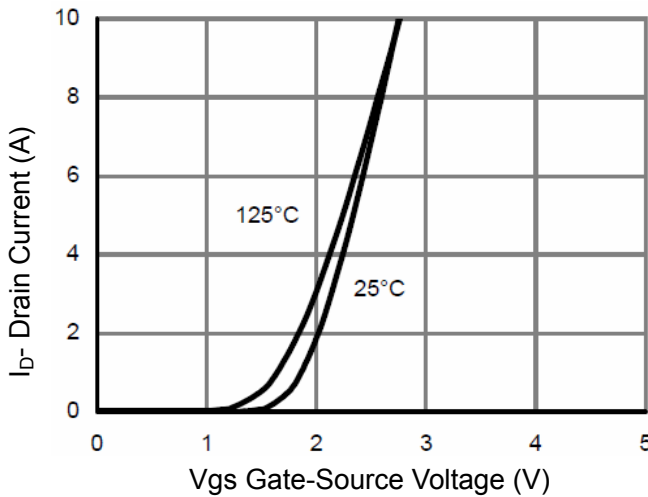
**3) Switch Time Test Circuit**



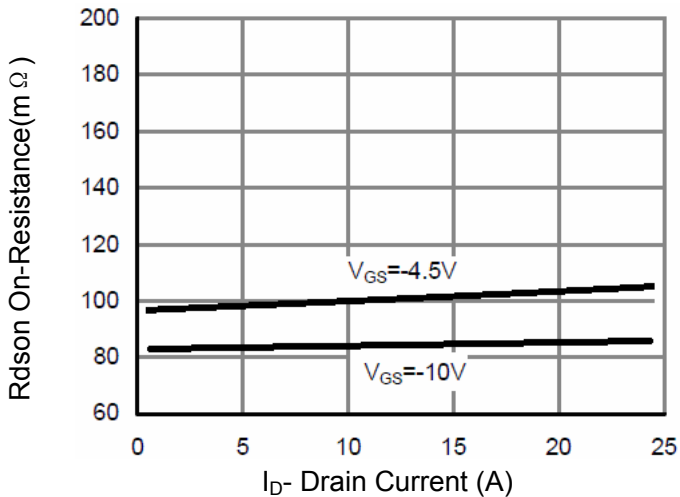
**Typical Electrical and Thermal Characteristics (Curves)**



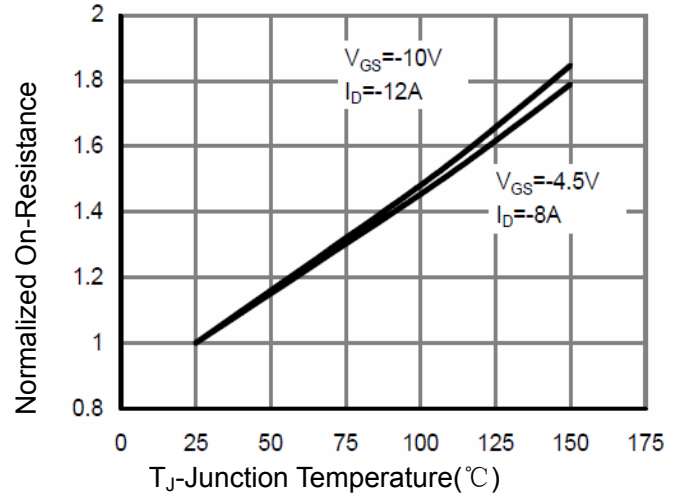
**Figure 1 Output Characteristics**



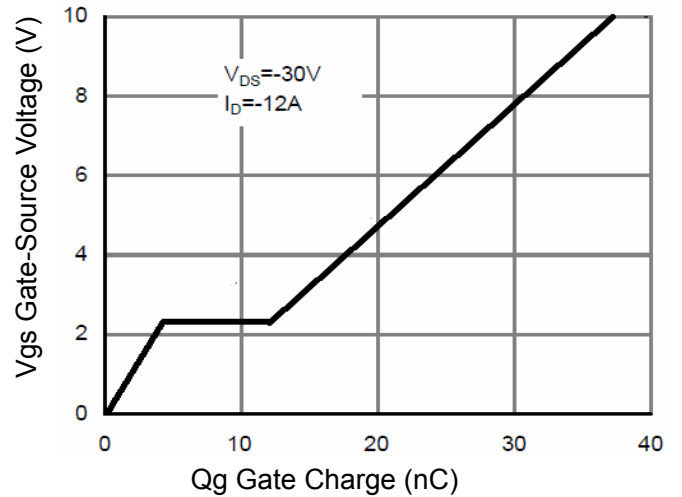
**Figure 2 Transfer Characteristics**



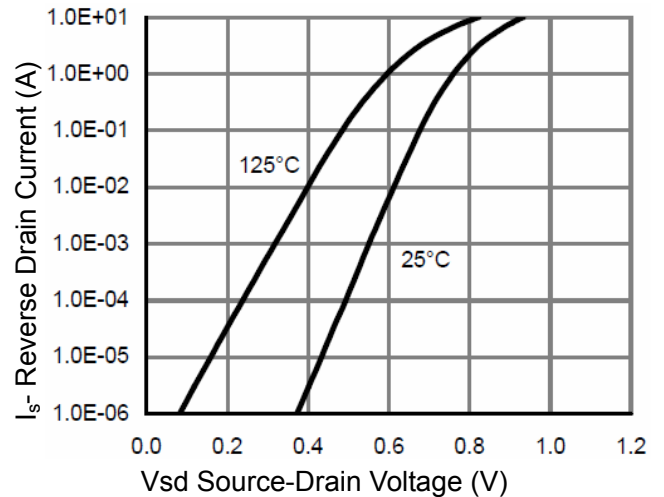
**Figure 3 Rdson- Drain Current**



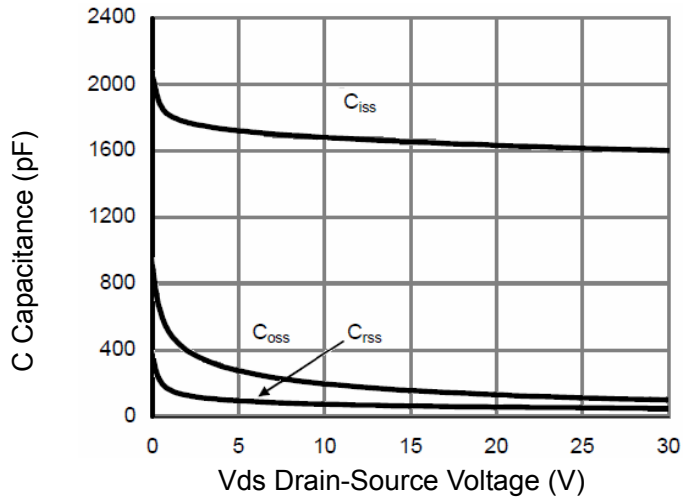
**Figure 4 Rdson-Junction Temperature**



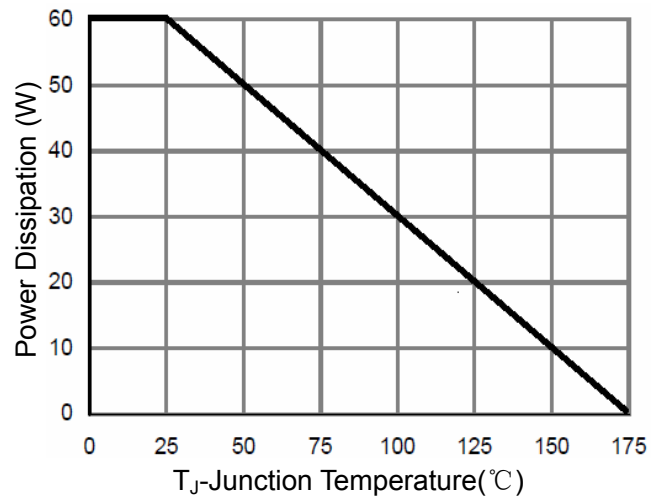
**Figure 5 Gate Charge**



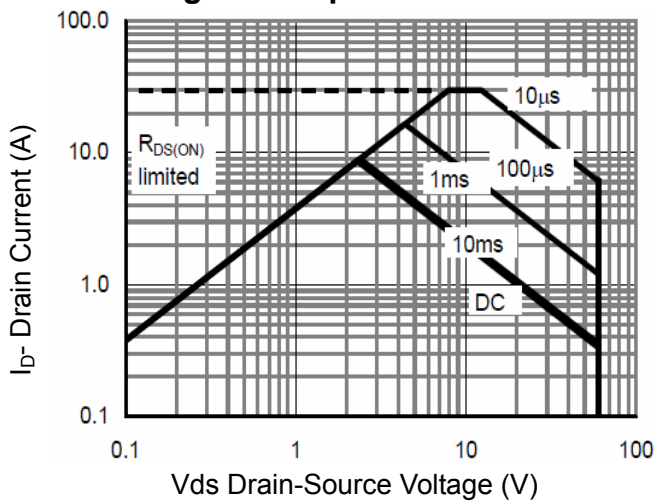
**Figure 6 Source- Drain Diode Forward**



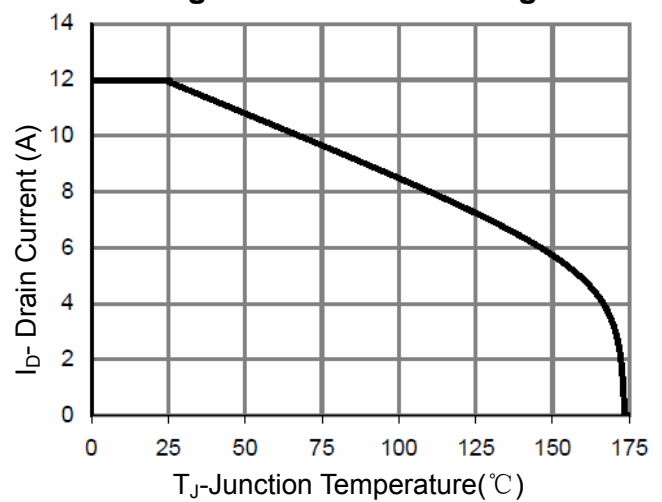
**Figure 7 Capacitance vs Vds**



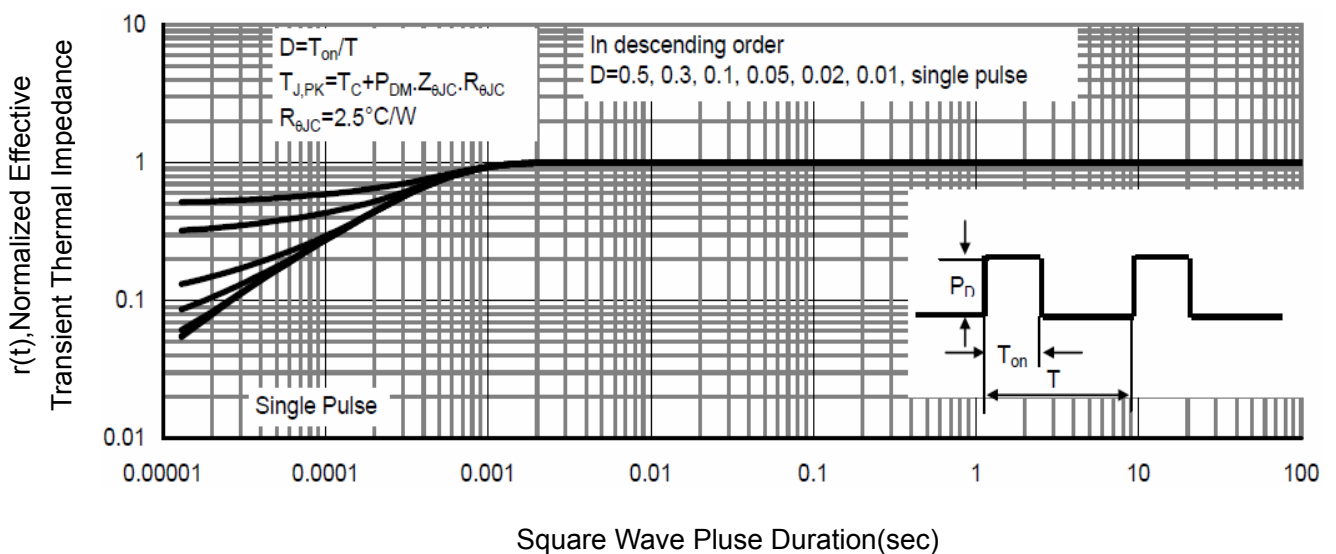
**Figure 9 Power De-rating**



**Figure 8 Safe Operation Area**

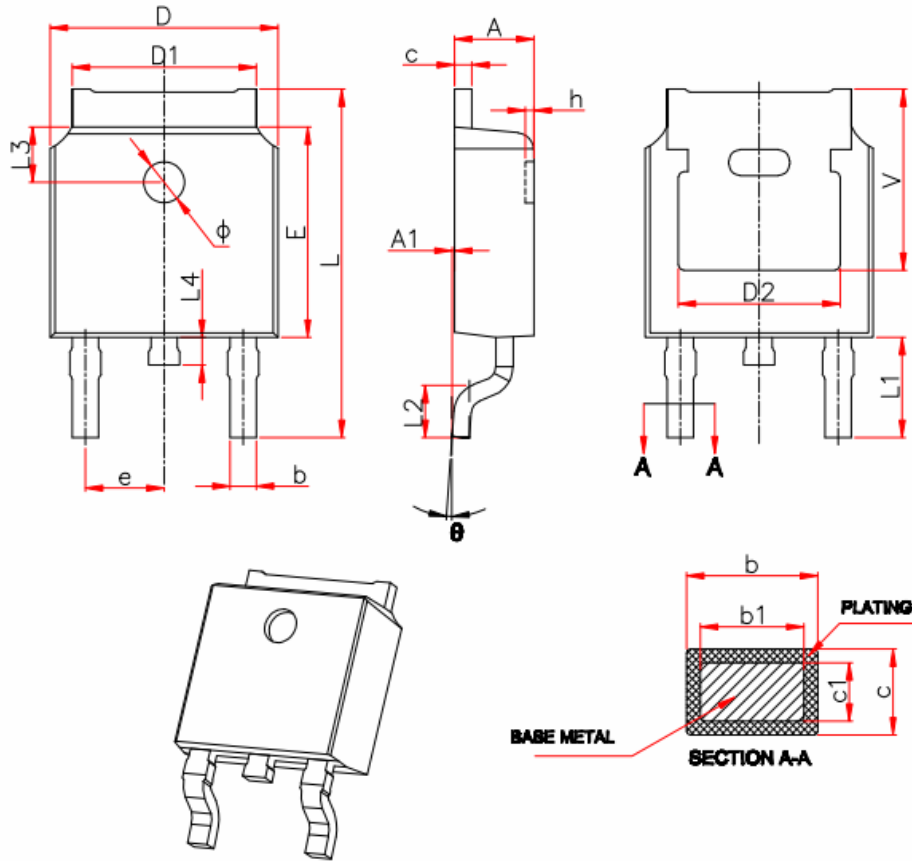


**Figure 10 ID Current De-rating**



**Figure 11 Normalized Maximum Transient Thermal Impedance**

**TO-252 Package Information**



Symbol	Millimeters	
	Min.	Max.
A	2.20	2.40
A1	0.00	0.13
b	0.66	0.86
b1	0.73	0.79
c	0.46	0.58
c1	0.50	0.52
D	6.50	6.70
D1	5.10	5.46
D2	4.83 REF.	
E	6.00	6.20
e	2.19	2.39
L	9.80	10.40
L1	2.90 REF.	
L2	1.40	1.70
L3	1.60 REF.	
L4	0.60	1.00
Φ	1.10	1.30
θ	0°	8°

### **Attention**

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